



## Revision History

| Date              | Notes  |
|-------------------|--|
| April 12, 2011    | Initial release.   |
| July 4, 2011      | Lot of updates and fixes.  |
| September 1, 2011 | Remove bump related spec and add some minor modifications.               |
| October 12, 2011  | Add pad sizes and die layout details.                                    |
| November 23, 2011 | Correct types for bits 0 & 1 in register 0X05.                           |
| January 25, 2012  | Add solder bump specification.   |
| February 27, 2012 | Add typical values for lcc1 and lcc2. Revised solder bump specification. |
| March 12, 2013    | Administrative error fix.  |
| January 22, 2018  | Changed to IDT Branding.   |



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